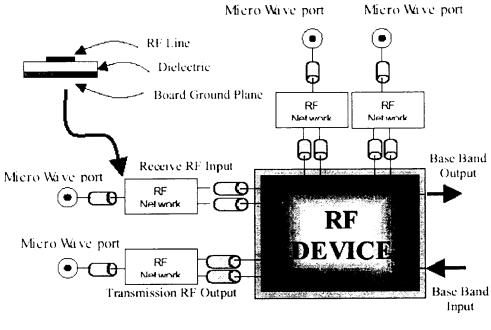
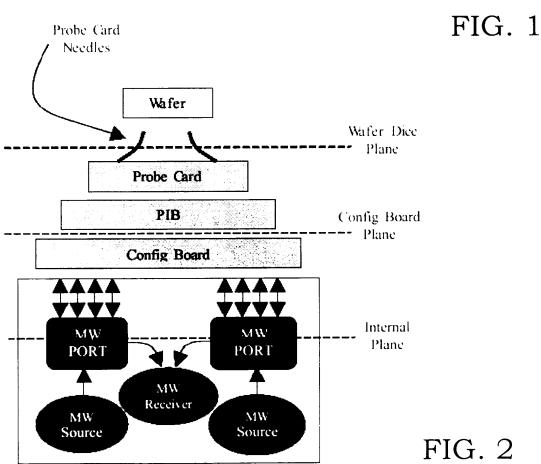
Title: TEST BOARD E-EMBEDDING METHOD TO IMPRODUCE RF MEASUREMENTS ACCURACY (N. AUTOMATIC TESTING EQUIPM FOR IC WAFERS





Title: TEST BOARD E-EMBEDDING METHOD TO IMPRO RF MEASUREMENTS ACCURACY (NAUTOMATIC TESTING EQUIPM FOR IC WAFERS

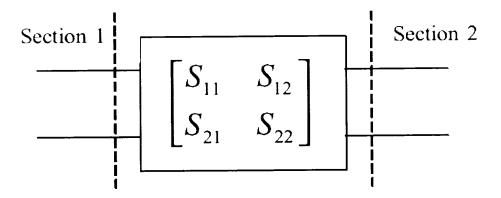


FIG. 3

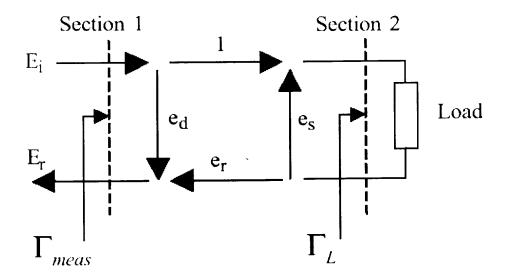


FIG. 4

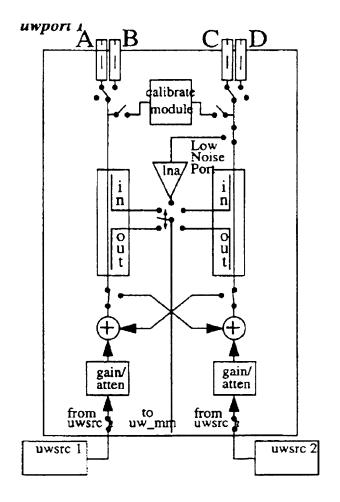


FIG. 5

Title: TEST BOARD SE-EMBEDDING METHOD TO IMPROSE RF MEASUREMENTS ACCURACY (N. AUTOMATIC TESTING EQUIPM) FOR IC WAFERS

File :: Uiew :: Sample from : Exp :: DATA: -0.39	q: 16.38MH2 535 to 0.3545	DISPLAY : +0.3538	to 0.3545	
52.00 1 1 1 1 1 1 1 1 1	27£3¥.♥			
w.m	ר י	Reflected	Reflected wave	
Incident wave		L		
wm day a second second second				
Omega e vice de la companya de la co				
yo ne e lee enng kesta e				
Marrie de la				
54m 3.5 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	SSu 600. Time secondo	4	Suu ?	S., 7

FIG. 6

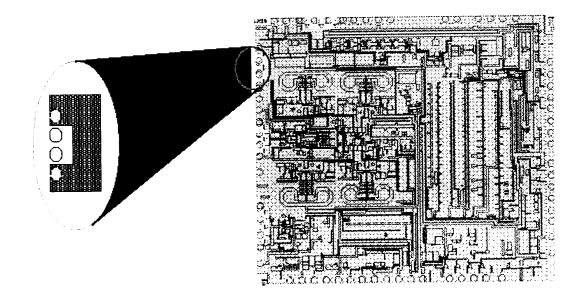


FIG. 7

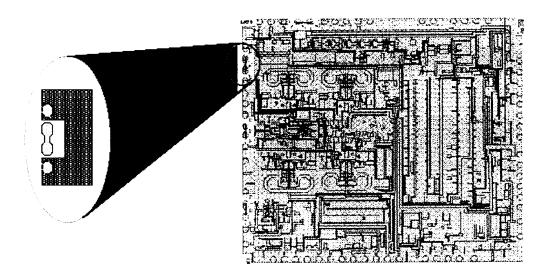


FIG. 8

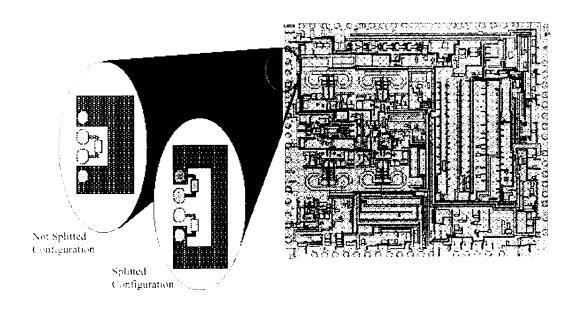
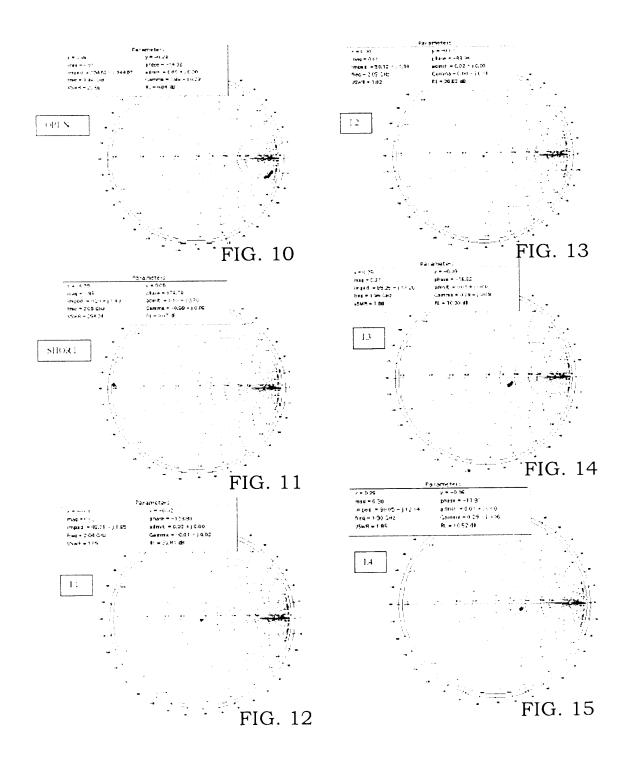


FIG. 9

Title: TEST BOARD RE-EMBEDDING METHOD TO IMPROVE RF MEASUREMENTS ACCURACY (N. AUTOMATIC TESTING EQUIPM). FOR IC WAFERS



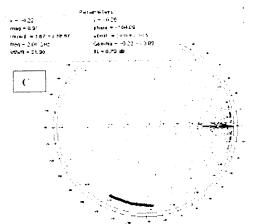


FIG. 16

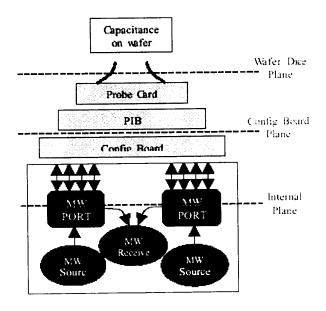


FIG. 17

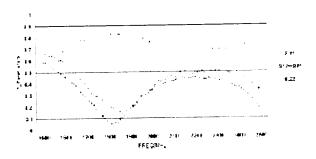


FIG. 18

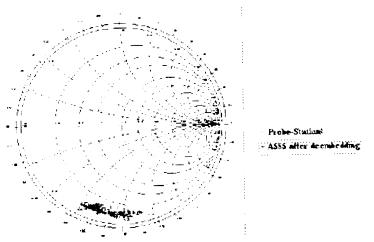


FIG. 19

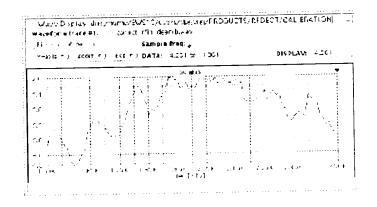


FIG. 20

Title: TEST BOARD RE-EMBEDDING METHOD TO IMPROVE RF MEASUREMENTS ACCURACY CON AUTOMATIC TESTING EQUIPM. FOR IC WAFERS

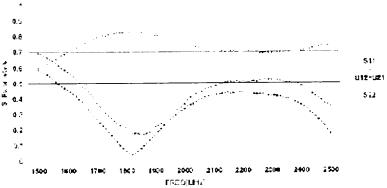


FIG. 21

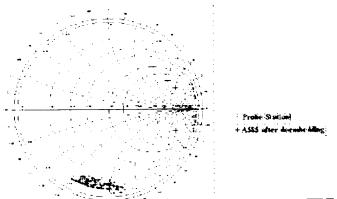


FIG. 22

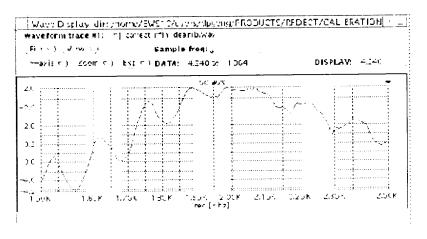
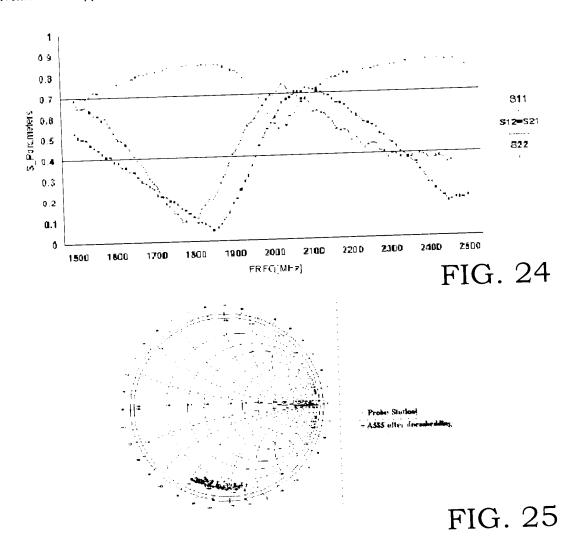
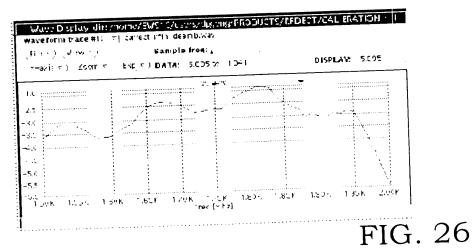


FIG. 23





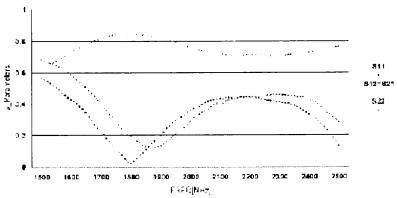


FIG. 27

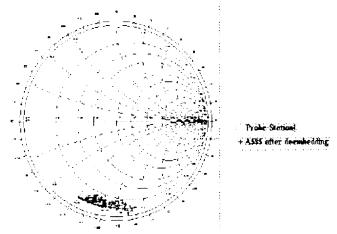


FIG. 28

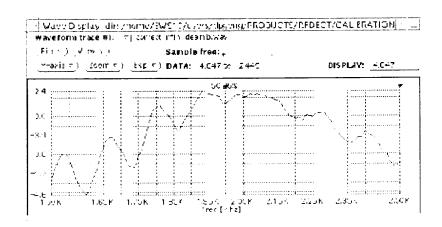


FIG. 29